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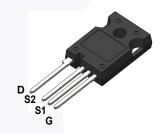
FCH041N65EFL4 N-Channel SuperFET[®] II FRFET[®] MOSFET 650 V, 76 A, 41 mΩ

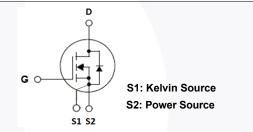
Features

- 700 V @ T_J = 150°C
- Typ. R_{DS(on)} = 36 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 229 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 631 pF)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- LCD / LED / PDP TV
 Telecom / Server Power Supplies
- Solar Inverter
- AC DC Power Supply





SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing

charge balance technology for outstanding low on-resistance

and lower gate charge performance. This technology is tailored

to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently,

SuperFET II MOSFET is very suitable for the switching power

applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SuperFET

I FRFET[®] MOSFET's optimized body diode reverse recovery performance can remove additional component and improve

Description

system reliability.

Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

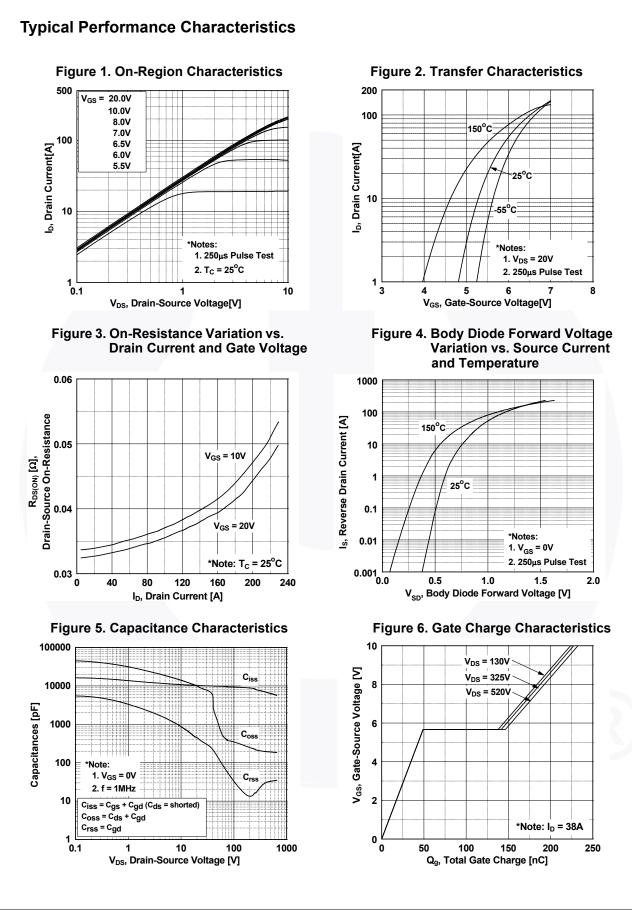
Symbol		FCH041N65EFL4	Unit			
V _{DSS}	Drain to Source Voltage		650	V		
V _{GSS}	Cata ta Cauraa Maltaga	- DC - AC (f > 1 Hz)		±20	V	
	Gate to Source Voltage			±30	v	
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		76	٨	
		- Continuous (T _C = 100 ^o C)		48.1	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	228	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			2025	mJ	
I _{AR}	Avalanche Current			15	Α	
E _{AR}	Repetitive Avalanche Energy (Not			5.95	mJ	
du/dt	MOSFET dv/dt	100	V/ns			
dv/dt	Peak Diode Recovery dv/dt (Note 3)				50	
P _D	Devuer Dissingtion	(T _C = 25 ^o C)		595	W	
	Power Dissipation	- Derate Above 25°C		4.76	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

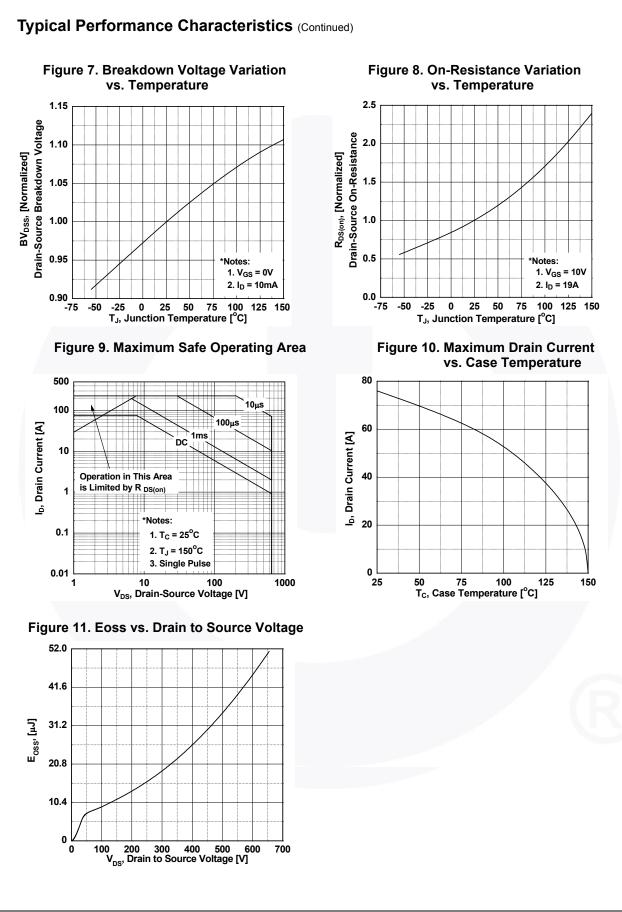
Thermal Characteristics

Symbol	Parameter	FCH041N65EFL4	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

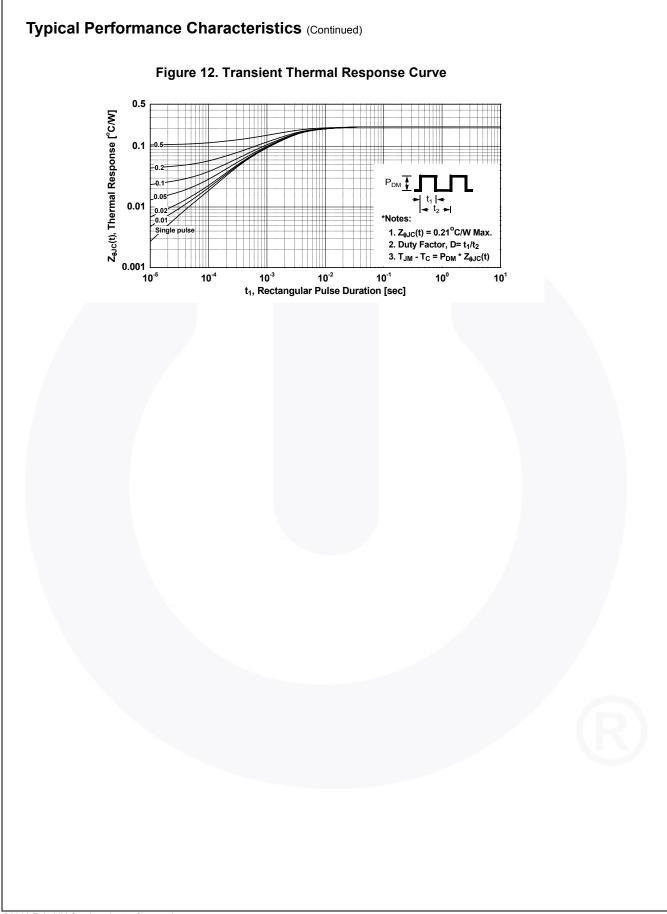
May 2016

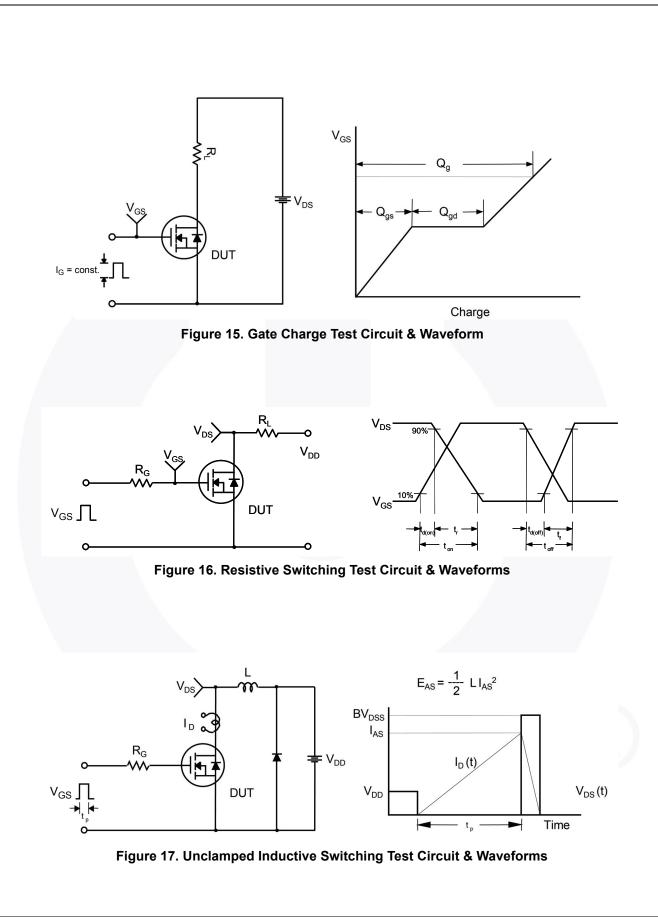
Part Number FCH041N65EFL4		Top Mark	Package	Packing Method Reel Size		Таре	e Width	Qua	ntity
		FCH041N65EF	TO-247 4L	Tube	N/A		N/A	30 u	inits
Electrica	Char	octorictics -	0500						
Symbol		acteristics ⊤ _C = Parameter	25°C unless	otherwise noted. Test Conditi	iono	Min.	Tun	Max.	Unit
				Test Conditi	0115	IVIIII.	Тур.	IVIAX.	UIII
Off Charac	teristics	6					1	1	1
BV _{DSS}	Drain to	rain to Source Breakdown Voltage		$V_{GS} = 0 V, I_{D} = 10 mA, T_{J} = 25^{\circ}C$		650	-	-	V
				$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150 \text{ °C}$ $I_{D} = 10 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$		700	-	-	
∆BV _{DSS} / ∆T _{.1}	Coefficie	own Voltage Temperature ent				-	0.72	-	V/ºC
<u> </u>				V _{DS} = 650 V, V _{GS} = 0 V		-	-	10	
DSS	Zero Ga	Zero Gate Voltage Drain Current Gate to Body Leakage Current		$V_{\rm DS} = 520 \text{ V}, \text{ T}_{\rm C} = 125^{\circ}\text{C}$		-	145	-	μA
GSS	Gate to			$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$		-	-	±100	nA
								1	
On Charac									1
V _{GS(th)}		reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 7.6 \text{ m}.$	A	3	-	5	V
R _{DS(on)}		rain to Source On Res	sistance	V _{GS} = 10 V, I _D = 38 A		-	36	41	mΩ
9 _{FS}	Forward	Transconductance		V_{DS} = 20 V, I_{D} = 38 A		-	71.7	-	S
Dynamic C	haracte	ristics							
C _{iss}	Input Capacitance					-	9446	12560	pF
C _{oss}	-	Capacitance		V _{DS} = 100 V, V _{GS} = 0 V,		-	366	490	pF
C _{rss}		Transfer Capacitance	e	_f = 1 MHz	-	_	35	_	pF
C _{oss}		Capacitance		V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		-	197	-	pF
C _{oss(eff.)}	-	e Output Capacitance		$V_{DS} = 0 V \text{ to } 400 V, V_{GS} = 0 V$ $V_{DS} = 380 V, I_D = 38 A,$			631	-	pF
Q _{g(tot)}		ate Charge at 10V				-	229	298	nC
Q _{gs}		Source Gate Charge		$V_{GS} = 10 V$.,	-	50	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge			(Note 4)	-	90	-	nC
ESR	Equivale	ent Series Resistance		f = 1 MHz		-	0.6	-	Ω
Switching	Charaot	ariatiaa							
Switching								400	r
t _{d(on)}		Delay Time		V _{DD} = 380 V, I _D = 38 A,			55	120	ns
t <u>r</u>		Turn-On Rise Time		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$		-	25	60	ns
t _{d(off)}	Turn-Off Delay Time Turn-Off Fall Time					-	169	348	ns
t _f	Turn-Off	Fail Time			(Note 4)		18	46	ns
Drain-Sou	rce Diod	le Characteristic	s						
Maximum Continuous Drain to Source Diode Forward Current						-	-	76	Α
I _{SM}	Maximur	um Pulsed Drain to Source Diode Fo		rward Current		-	-	228	Α
V _{SD}	Drain to	Source Diode Forwar	d Voltage	V _{GS} = 0 V, I _{SD} = 38 A		-		1.2	V
t _{rr}	Reverse	Recovery Time		V _{GS} = 0 V, I _{SD} = 38 A,		-	207	-	ns
Q _{rr}	Reverse	Recovery Charge		dI _F /dt = 100 A/µs		-	1.5	-	μC
lotes:								1	
. Repetitive rating	g: pulse width	limited by maximum junction	temperature.						
2. I _{AS} = 15 A, R _G =									
		$V_{DD} \le 380$ V, starting T _J = 25° erating temperature typical c							
	pendent of op	crating temperature typical e	naraciensiics.						



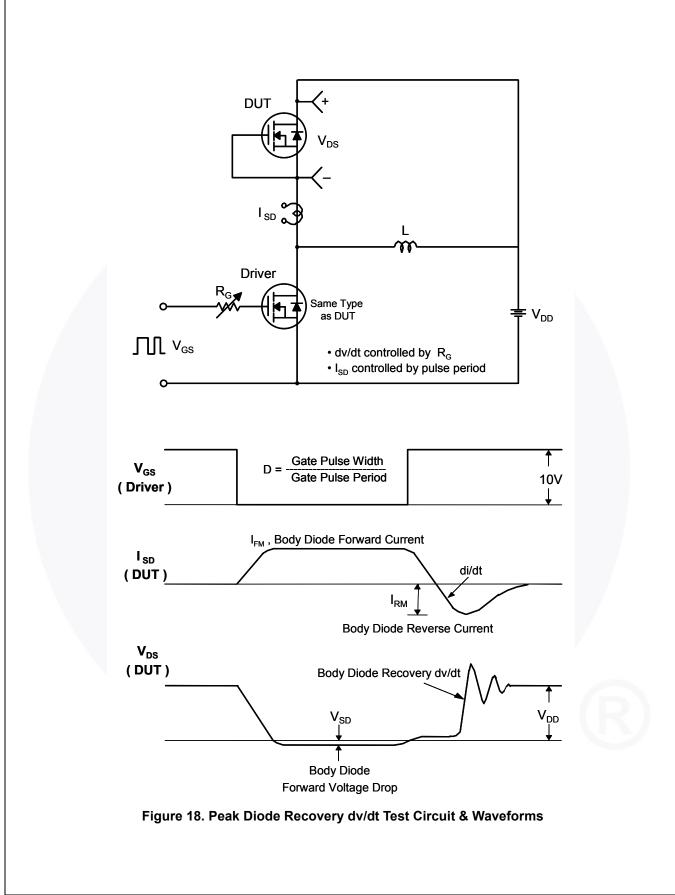


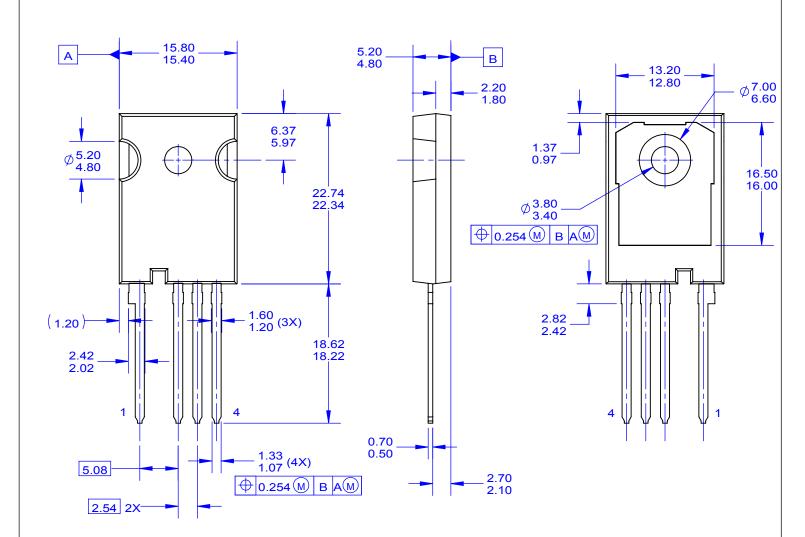
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FCH041N65EFL4 — N-Channel SuperFET[®] II FRFET[®] MOSFET





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